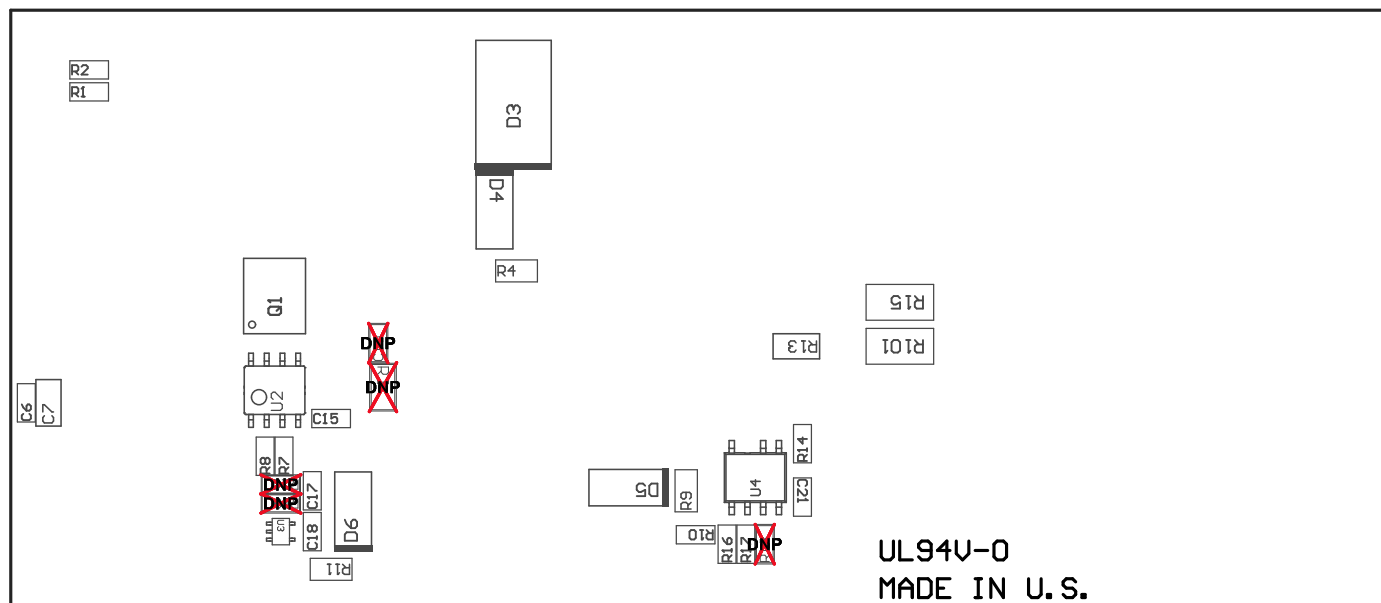


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: PMP10407

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
IGNORE -> Top Overlay			
PLOT NAME = Top Assembly Drawing	GENERATED : 5/6/2015	12:13:24 AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: PMP10407

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
	IGNORE -> Bottom Overlay		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 5/6/2015	12:13:28 AM	TEXAS INSTRUMENTS

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